



## DRV5053 Analog-Bipolar Hall Effect Sensor

### 1 Features

- Linear Output Hall Sensor
- Superior Temperature Stability
  - Sensitivity  $\pm 10\%$  Over Temperature
- High Sensitivity Options:
  - $-11$  mV/mT (OA)
  - $-23$  mV/mT (PA)
  - $-45$  mV/mT (RA)
  - $-90$  mV/mT (VA)
  - $+23$  mV/mT (CA)
  - $+45$  mV/mT (EA)
- Supports a Wide Voltage Range
  - 2.5 to 38 V
  - No External Regulator Required
- Wide Operating Temperature Range
  - $T_A = -40$  to  $125^\circ\text{C}$  (Q)
- Amplified Output Stage
  - 2.3-mA Sink, 300  $\mu\text{A}$  Source
- Output voltage: 0.2 ~ 1.8 V
  - $B = 0$  mT,  $\text{OUT} = 1$  V
- Fast Power-On: 35  $\mu\text{s}$
- Small Package and Footprint
  - Surface Mount 3-Pin SOT-23 (DBZ)
    - 2.92 mm  $\times$  2.37 mm
  - Through-Hole 3-Pin SIP (LPG)
    - 4.00 mm  $\times$  3.15 mm
- **Protection Features**
  - Reverse Supply Protection (up to  $-22$  V)
  - Supports up to 40-V Load Dump
  - Output Short-Circuit Protection
  - Output Current Limitation

### 2 Applications

- Flow Meters
- Docking Adjustment
- Vibration Correction
- Damper Controls

### 3 Description

The DRV5053 device is a chopper-stabilized Hall IC that offers a magnetic sensing solution with superior sensitivity stability over temperature and integrated protection features.

The 0- to 2-V analog output responds linearly to the applied magnetic flux density, and distinguishes the polarity of magnetic field direction. A wide operating voltage range from 2.5 to 38 V with reverse polarity protection up to  $-22$  V makes the device suitable for a wide range of industrial and consumer applications.

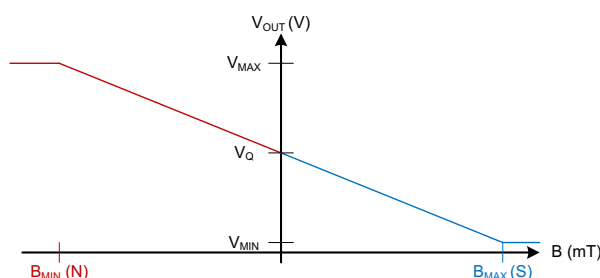
Internal protection functions are provided for reverse supply conditions, load dump, and output short circuit or overcurrent.

**Device Information<sup>(1)</sup>**

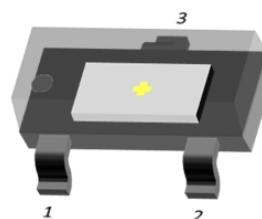
PART NUMBER	PACKAGE	BODY SIZE (NOM)
DRV5053	SOT-23 (3)	2.92 mm $\times$ 2.37 mm
	SIP (3)	4.00 mm $\times$ 3.15 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

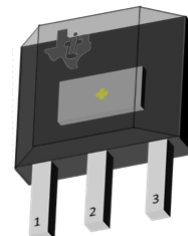
### 4 Output State



**SOT-23**



**SIP**



## Table of Contents

<b>1 Features</b> .....	<b>1</b>	<b>8 Detailed Description</b> .....	<b>8</b>
<b>2 Applications</b> .....	<b>1</b>	8.1 Overview .....	8
<b>3 Description</b> .....	<b>1</b>	8.2 Functional Block Diagram .....	8
<b>4 Output State</b> .....	<b>1</b>	8.3 Feature Description .....	9
<b>5 Revision History</b> .....	<b>2</b>	8.4 Device Functional Modes .....	11
<b>6 Pin Configuration and Functions</b> .....	<b>3</b>	<b>9 Application and Implementation</b> .....	<b>12</b>
<b>7 Specifications</b> .....	<b>4</b>	9.1 Application Information .....	12
7.1 Absolute Maximum Ratings .....	4	9.2 Typical Applications .....	12
7.2 Handling Ratings .....	4	<b>10 Power Supply Recommendations</b> .....	<b>14</b>
7.3 Recommended Operating Conditions .....	4	<b>11 Device and Documentation Support</b> .....	<b>15</b>
7.4 Thermal Information .....	4	11.1 Device Support .....	15
7.5 Electrical Characteristics .....	5	11.2 Trademarks .....	16
7.6 Switching Characteristics .....	5	11.3 Electrostatic Discharge Caution .....	16
7.7 Magnetic Characteristics .....	5	11.4 Glossary .....	16
7.8 Typical Characteristics .....	7	<b>12 Mechanical, Packaging, and Orderable Information</b> .....	<b>16</b>

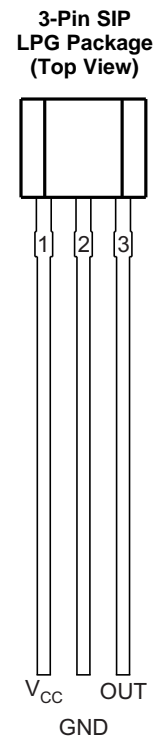
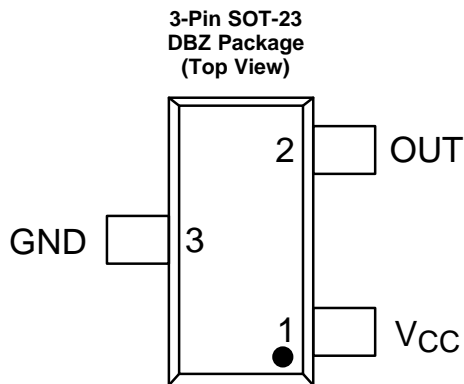
## 5 Revision History

<b>Changes from Revision A (August 2014) to Revision B</b>	<b>Page</b>
• Updated high sensitivity options .....	1
• Updated the sensitivity device values and typicals. Updated typical and max values for DRV5053VA: –80 mV/mT .....	6
• Updated <i>Typical Characteristics</i> graphs .....	7

<b>Changes from Original (May 2014) to Revision A</b>	<b>Page</b>
• Updated device status to production data .....	1
• Changed the maximum T <sub>J</sub> value from 175°C to 150°C .....	4
• Updated <i>Magnetic Characteristics</i> table. ....	5

## 6 Pin Configuration and Functions

For additional configuration information, see [Device Markings](#) and [Mechanical, Packaging, and Orderable Information](#).



**Pin Functions**

NAME	PIN NUMBER		TYPE	DESCRIPTION
	DBZ	LPG		
GND	3	2	GND	Ground pin
V <sub>CC</sub>	1	1	Power	2.5 to 38 V power supply. Bypass this pin to the GND pin with a 0.01-μF (minimum) ceramic capacitor rated for V <sub>CC</sub> .
OUT	2	3	Output	Hall sensor analog output. 1 V output corresponds to B = 0 mT

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
Power supply voltage	V <sub>CC</sub>	–22 <sup>(2)</sup>	40	V
	Voltage ramp rate (V <sub>CC</sub> ), V <sub>CC</sub> < 5 V	Unlimited		V/μs
	Voltage ramp rate (V <sub>CC</sub> ), V <sub>CC</sub> > 5 V	0	2	
Output pin voltage	OUT	–0.5	2.5	V
Output pin reverse current during reverse supply condition	OUT	0	–20	mA
Operating junction temperature	T <sub>J</sub>	–40	150 <sup>(3)</sup>	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Ensured by design. Only tested to –20 V.
- (3) Tested in production to T<sub>A</sub> = 125°C.

### 7.2 Handling Ratings

		MIN	MAX	UNIT
T <sub>stg</sub>	Storage temperature range	–65	150	°C
V <sub>(ESD)</sub>	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>		kV
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>		V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V <sub>CC</sub>	Power supply voltage	2.5	38	V
V <sub>OUT</sub>	Output pin voltage (OUT)	0	2	V
I <sub>SOURCE</sub>	Output pin current source (OUT)	0	300	μA
I <sub>SINK</sub>	Output pin current sink (OUT)	0	2.3	mA
T <sub>A</sub>	Operating ambient temperature	–40	125	°C

### 7.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>		DRV5053		UNIT
		DBZ	LPG	
		3 PINS	3 PINS	
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	333.2	180	°C/W
R <sub>θJC(top)</sub>	Junction-to-case (top) thermal resistance	99.9	98.6	
R <sub>θJB</sub>	Junction-to-board thermal resistance	66.9	154.9	
ψ <sub>JT</sub>	Junction-to-top characterization parameter	4.9	40	
ψ <sub>JB</sub>	Junction-to-board characterization parameter	65.2	154.9	

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 7.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>POWER SUPPLIES (V<sub>CC</sub>)</b>						
V <sub>CC</sub>	V <sub>CC</sub> operating voltage		2.5		38	V
I <sub>CC</sub>	Operating supply current	V <sub>CC</sub> = 2.5 to 38 V, T <sub>A</sub> = 25°C		2.7		mA
		V <sub>CC</sub> = 2.5 to 38 V, T <sub>A</sub> = 125°C		3	3.6	
t <sub>on</sub>	Power-on time			35	50	μs
<b>PROTECTION CIRCUITS</b>						
V <sub>CCR</sub>	Reverse supply voltage		–22			V
I <sub>OCPSOURCE</sub>	Overcurrent protection level	Sourcing current		300		μA
I <sub>OCPSINK</sub>	Overcurrent protection level	Sinking current		2.3		mA

## 7.6 Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>ANALOG OUTPUT (OUT)</b>						
t <sub>d</sub>	Output delay time	T <sub>A</sub> = 25°C		13	25	μs

## 7.7 Magnetic Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT <sup>(1)</sup>
V <sub>Q</sub>	Quiescent output	B = 0 mT T <sub>A</sub> = –40°C to 125°C	0.9	1.02	1.15	V
f <sub>BW</sub>	Bandwidth <sup>(2)</sup>		20			kHz
B <sub>N</sub>	Input-referred noise <sup>(3)</sup>	C <sub>OUT</sub> = 50 pF T <sub>A</sub> = –40°C to 125°C	0.40	0.58	0.79	mT <sub>pp</sub>
Le	Linearity <sup>(4)</sup>	–B <sub>SAT</sub> < B < B <sub>SAT</sub>		1%		
V <sub>OUT MIN</sub>	Output saturation voltage (min)	B < –B <sub>SAT</sub>			0.2	V
V <sub>OUT MAX</sub>	Output saturation voltage (max)	B > B <sub>SAT</sub>	1.8			V
<b>DRV5053OA: –11 mV/mT</b>						
S	Sensitivity	V <sub>CC</sub> = 3.3 V T <sub>A</sub> = –40°C ~ 125°C	–17.5	–11	–5	mV/mT
V <sub>N</sub>	Output-referred noise <sup>(3)</sup>	V <sub>CC</sub> = 3.3 V; R <sub>OUT</sub> = 10 kΩ; C <sub>OUT</sub> = 50 pF T <sub>A</sub> = –40°C ~ 125°C		6		mV <sub>pp</sub>
B <sub>SAT</sub>	Input saturation field	V <sub>CC</sub> = 3.3 V T <sub>A</sub> = –40°C ~ 125°C		73		mT
<b>DRV5053PA: –23 mV/mT</b>						
S	Sensitivity	V <sub>CC</sub> = 3.3 V T <sub>A</sub> = –40°C ~ 125°C	–35	–23	–10	mV/mT
V <sub>N</sub>	Output-referred noise <sup>(3)</sup>	V <sub>CC</sub> = 3.3 V; R <sub>OUT</sub> = 10 kΩ; C <sub>OUT</sub> = 50 pF T <sub>A</sub> = –40°C ~ 125°C		13		mV <sub>pp</sub>
B <sub>SAT</sub>	Input saturation field	V <sub>CC</sub> = 3.3 V T <sub>A</sub> = –40°C ~ 125°C		35		mT

(1) 1 mT = 10 Gauss

(2) Bandwidth describes the fastest changing magnetic field that can be detected and translated to the output.

(3) Not tested in production; limits are based on characterization data.

(4) Linearity describes the change in sensitivity across the B-range. The sensitivity near B<sub>SAT</sub> is typically within 1% of the sensitivity near B = 0.

**DRV5053**

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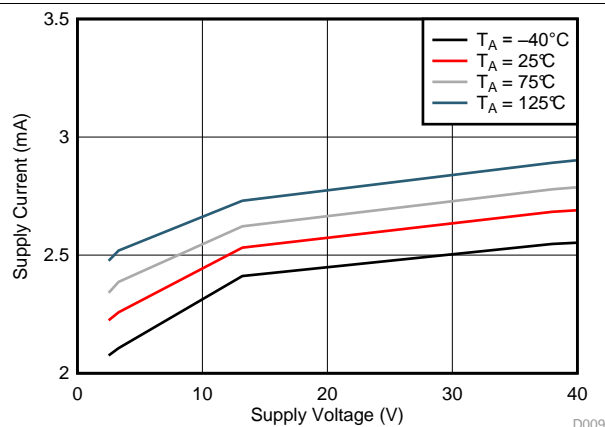
[www.ti.com](http://www.ti.com)
**Magnetic Characteristics (continued)**

over operating free-air temperature range (unless otherwise noted)

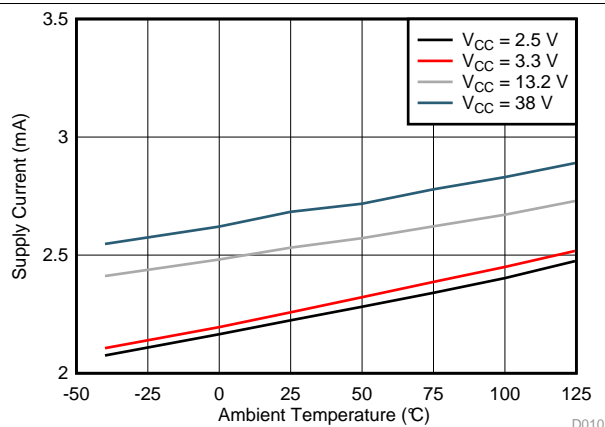
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT <sup>(1)</sup>
<b>DRV5053RA: –45 mV/mT</b>						
S	Sensitivity	$V_{CC} = 3.3\text{ V}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$	–70	–45	–20	mV/mT
$V_N$	Output-referred noise <sup>(5)</sup>	$V_{CC} = 3.3\text{ V}$ ; $R_{OUT} = 10\text{ k}\Omega$ ; $C_{OUT} = 50\text{ pF}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$		26		mV <sub>pp</sub>
$B_{SAT}$	Input saturation field	$V_{CC} = 3.3\text{ V}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$		18		mT
<b>DRV5053VA: –90 mV/mT</b>						
S	Sensitivity	$V_{CC} = 3.3\text{ V}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$	–140	–90	–45	mV/mT
$V_N$	Output-referred noise <sup>(5)</sup>	$V_{CC} = 3.3\text{ V}$ ; $R_{OUT} = 10\text{ k}\Omega$ ; $C_{OUT} = 50\text{ pF}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$		52		mV <sub>pp</sub>
$B_{SAT}$	Input saturation field	$V_{CC} = 3.3\text{ V}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$		9		mT
<b>DRV5053CA: 23 mV/mT</b>						
S	Sensitivity	$V_{CC} = 3.3\text{ V}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$	10	23	35	mV/mT
$V_N$	Output-referred noise <sup>(5)</sup>	$V_{CC} = 3.3\text{ V}$ ; $R_{OUT} = 10\text{ k}\Omega$ ; $C_{OUT} = 50\text{ pF}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$		13		mV <sub>pp</sub>
$B_{SAT}$	Input saturation field	$V_{CC} = 3.3\text{ V}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$		35		mT
<b>DRV5053EA: 45 mV/mT</b>						
S	Sensitivity	$V_{CC} = 3.3\text{ V}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$	20	45	70	mV/mT
$V_N$	Output-referred noise <sup>(5)</sup>	$V_{CC} = 3.3\text{ V}$ ; $R_{OUT} = 10\text{ k}\Omega$ ; $C_{OUT} = 50\text{ pF}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$		26		mV <sub>pp</sub>
$B_{SAT}$	Input saturation field	$V_{CC} = 3.3\text{ V}$ $T_A = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$		18		mT

(5) Not tested in production; limits are based on characterization data.

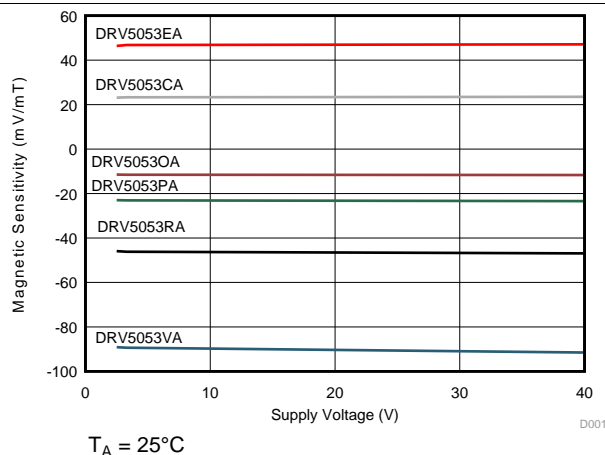
## 7.8 Typical Characteristics



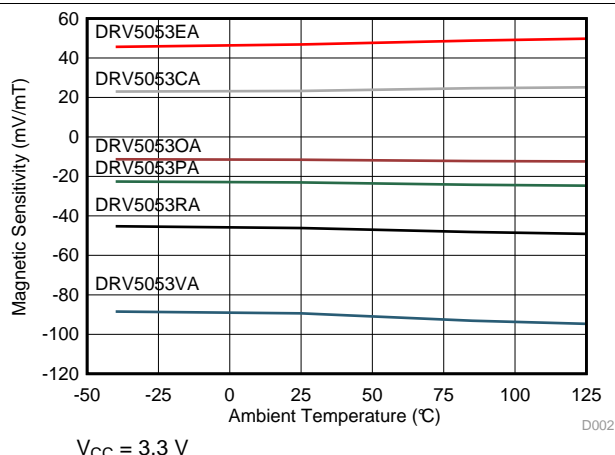
**Figure 1.  $I_{CC}$  vs  $V_{CC}$**



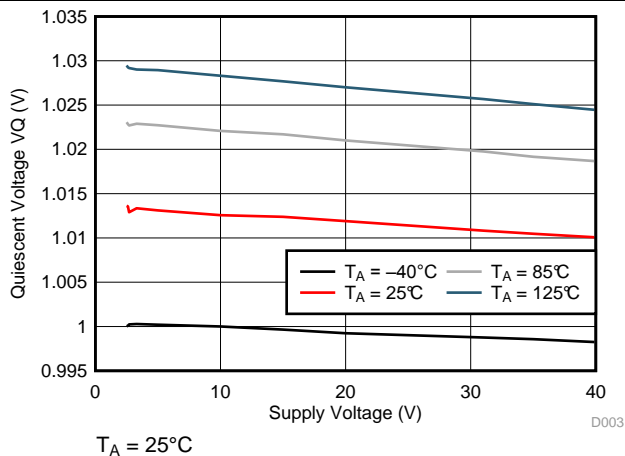
**Figure 2.  $I_{CC}$  vs Temperature**



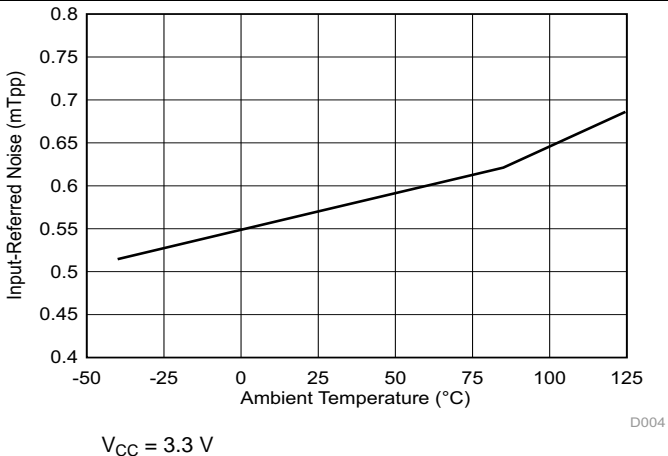
**Figure 3. Sensitivity vs  $V_{CC}$**



**Figure 4. Sensitivity vs Temperature**



**Figure 5. DRV5053AD,  $V_Q$  vs  $V_{CC}$**



**Figure 6. DRV5053AD,  $B_N$  vs Temperature**

## 8 Detailed Description

### 8.1 Overview

The DRV5053 device is a chopper-stabilized hall sensor with an analog output for magnetic sensing applications. The DRV5053 device can be powered with a supply voltage between 2.5 and 38 V, and will survive  $-22$  V reverse battery conditions continuously. Note that the DRV5053 device will not be operating when approximately  $-22$  to  $2.4$  V is applied to  $V_{CC}$  (with respect to GND). In addition, the device can withstand supply voltages up to  $40$  V for transient durations.

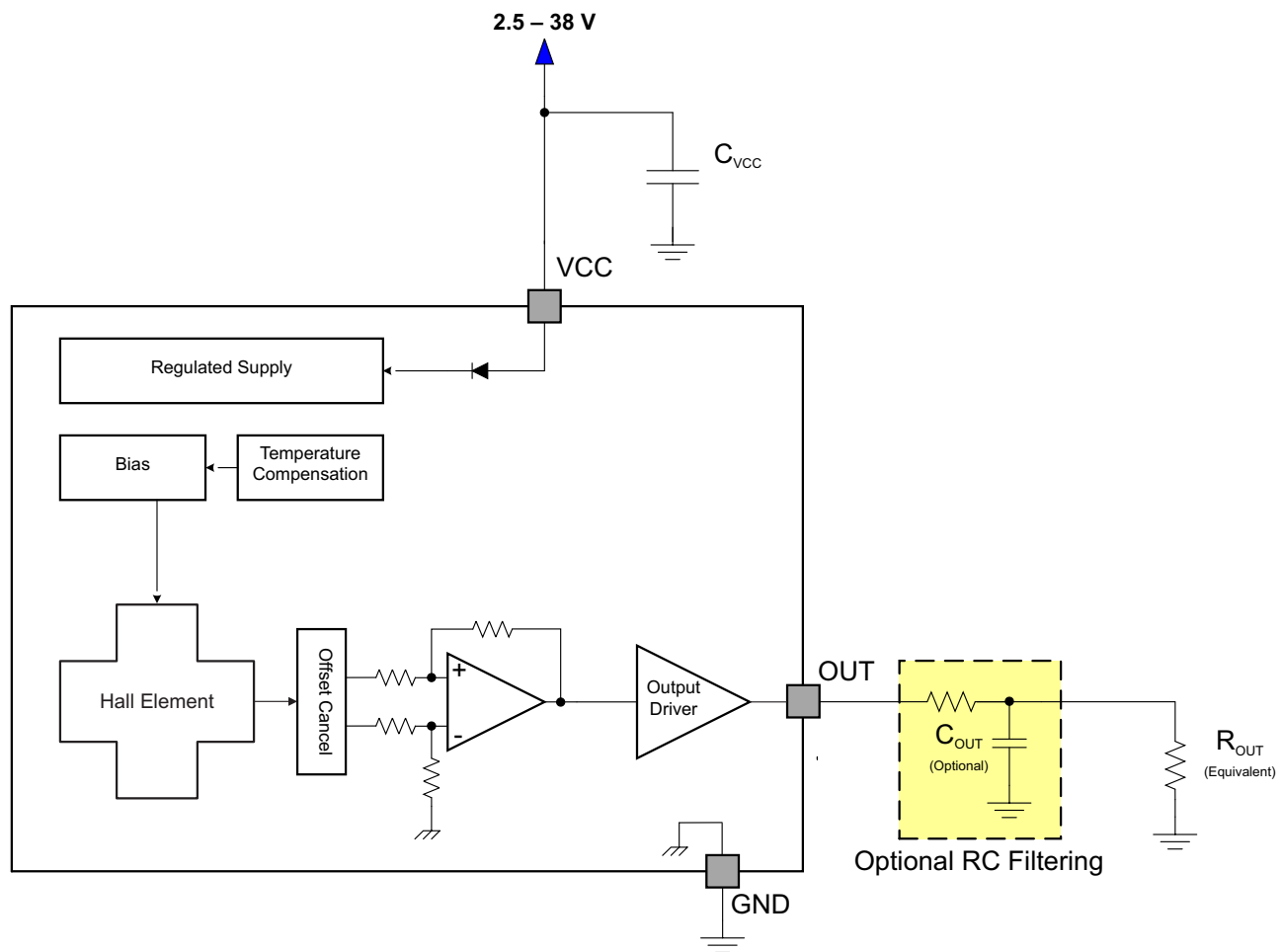
The output voltage is dependent on the magnetic field perpendicular to the package. The absence of a magnetic field will result in  $OUT = 1$  V. A magnetic field will cause the output voltage to change linearly with the magnetic field.

The field polarity is defined as follows: a **south pole** near the marked side of the package is a positive magnetic field. A **north pole** near the marked side of the package is a negative magnetic field.

For devices with a negative sensitivity (that is, DRV5053RA:  $-40$  mV/mT), a **south pole** will cause the output voltage to drop below  $1$  V, and a north pole will cause the output to rise above  $1$  V.

For devices with a positive sensitivity (that is, DRV5053EA:  $+40$  mV/mT), a **south pole** will cause the output voltage to rise above  $1$  V, and a north pole will cause the output to drop below  $1$  V.

### 8.2 Functional Block Diagram

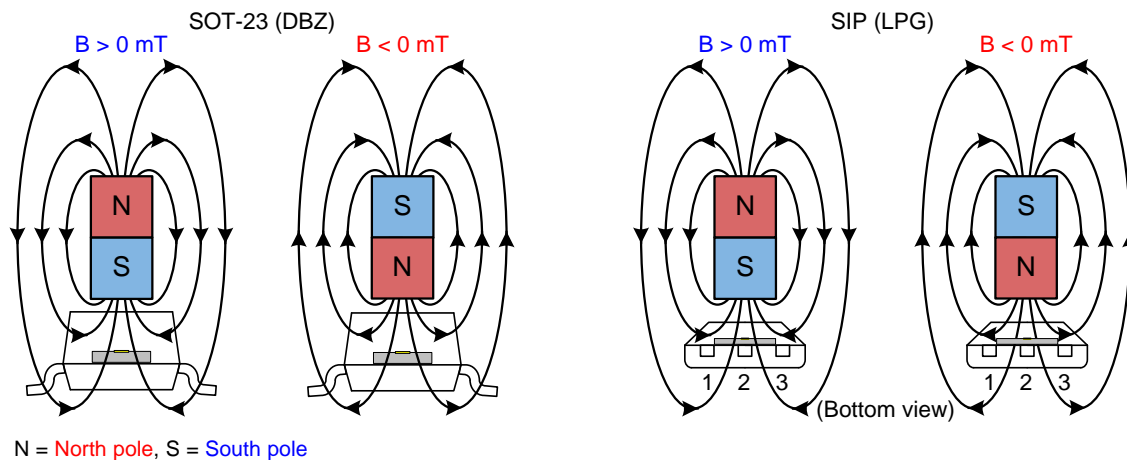




## 8.3 Feature Description

### 8.3.1 Field Direction Definition

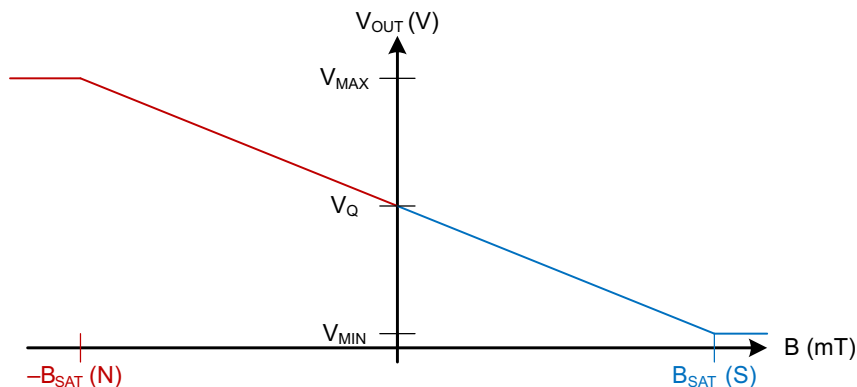
A positive magnetic field is defined as a **south pole** near the marked side of the package as shown in [Figure 7](#).



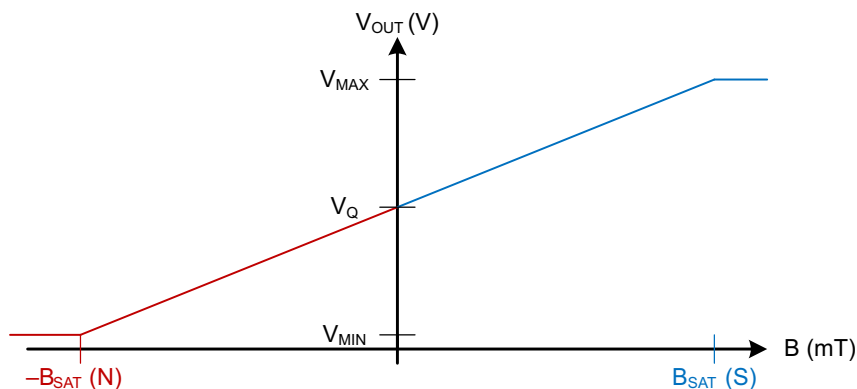
**Figure 7. Field Direction Definition**

### 8.3.2 Device Output

The DRV5053 device output is defined below for negative sensitivity (that is,  $-45 \text{ mV/mT}$ , RA) and positive sensitivity (that is,  $+45 \text{ mV/mT}$ , EA):



**Figure 8. DRV5053 – Negative Sensitivity**

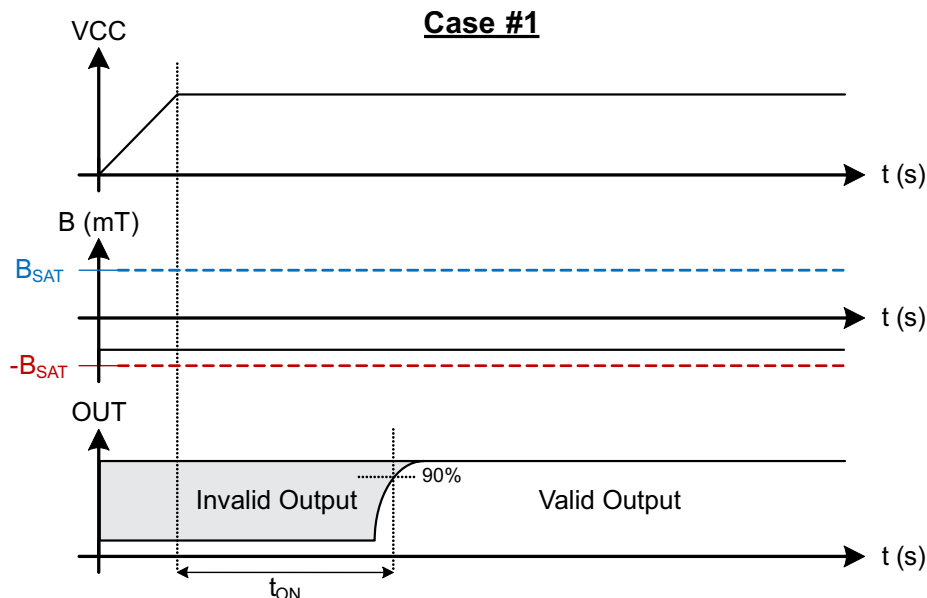


**Figure 9. DRV5053 – Positive Sensitivity**

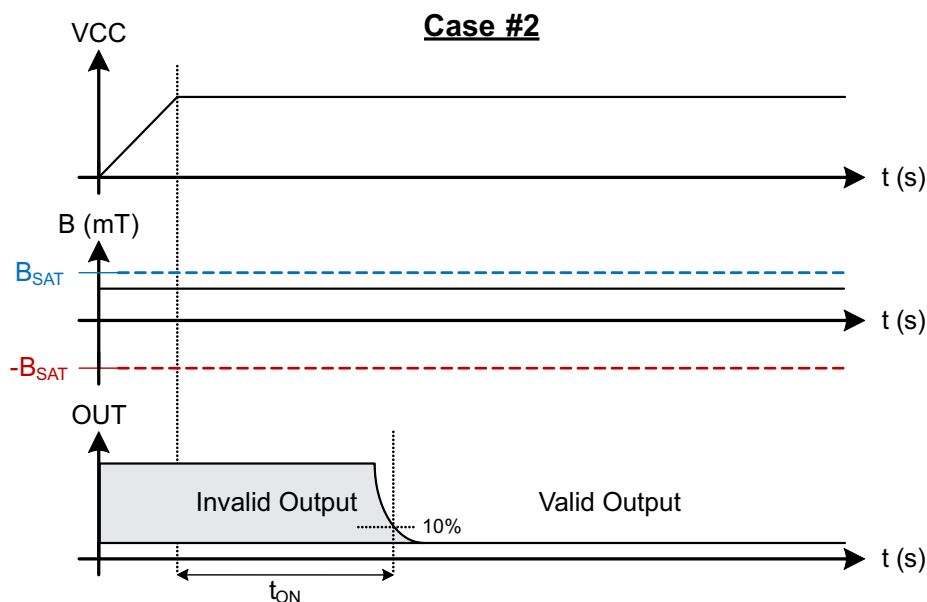
## Feature Description (continued)

### 8.3.3 Power-On Time

After applying  $V_{CC}$  to the DRV5053 device,  $t_{on}$  must elapse before OUT is valid. [Figure 10](#) shows Case 1 and [Figure 11](#) shows case 2; the output is defined assuming a negative sensitivity device and a constant magnetic field  $-B_{SAT} < B < B_{SAT}$ .



**Figure 10. Case 1: Power On When  $B < 0$ , North**



**Figure 11. Case 2: Power On When  $B > 0$ , South**

## Feature Description (continued)

### 8.3.4 Output Stage

The DRV5053 output stage is capable of up to 300  $\mu$ A of current source or 2.3 mA sink.

For proper operation, ensure that equivalent output load  $R_{OUT} > 10\text{ k}\Omega$ . In addition, ensure that the load capacitance  $C_{OUT} < 10\text{ nF}$ .

### 8.3.5 Protection Circuits

An analog current limit circuit limits the current through the output driver. The driver current will be clamped to  $I_{OCP}$ .

#### 8.3.5.1 Overcurrent Protection (OCP)

An analog current-limit circuit limits the current through the FET. The driver current is clamped to  $I_{OCP}$ . During this clamping, the  $r_{DS(on)}$  of the output FET is increased from the nominal value.

#### 8.3.5.2 Load Dump Protection

The DRV5053 device operates at DC  $V_{CC}$  conditions up to 38 V nominally, and can additionally withstand  $V_{CC} = 40\text{ V}$ . No current-limiting series resistor is required for this protection.

#### 8.3.5.3 Reverse Supply Protection

The DRV5053 device is protected in the event that the  $V_{CC}$  pin and the GND pin are reversed (up to  $-22\text{ V}$ ).

#### NOTE

In a reverse supply condition, the OUT pin reverse-current must not exceed the ratings specified in the [Absolute Maximum Ratings](#).

FAULT	CONDITION	DEVICE	DESCRIPTION	RECOVERY
FET overload (OCP)	$I_{SINK} \geq I_{OCP}$	Operating	Output current is clamped to $I_{OCP}$	$I_O < I_{OCP}$
Load Dump	$38\text{ V} < V_{CC} < 40\text{ V}$	Operating	Device will operate for a transient duration	$V_{CC} \leq 38\text{ V}$
Reverse Supply	$-22\text{ V} < V_{CC} < 0\text{ V}$	Disabled	Device will survive this condition	$V_{CC} \geq 2.5\text{ V}$

## 8.4 Device Functional Modes

The DRV5053 device is active only when  $V_{CC}$  is between 2.5 and 38 V.

When a reverse supply condition exists, the device is inactive.

## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The DRV5053 device is used in magnetic-field sensing applications.

### 9.2 Typical Applications

#### 9.2.1 Typical Application With No Filter

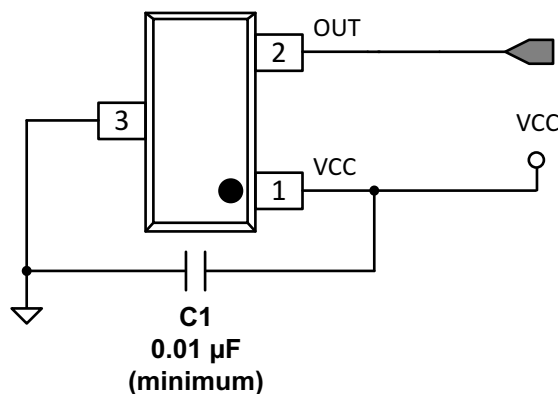


Figure 12. Typical Application Schematic – No Filter

##### 9.2.1.1 Design Requirements

For this design example, use the parameters listed in Table 1 as the input parameters.

Table 1. Design Parameters

DESIGN PARAMETER	REFERENCE	EXAMPLE VALUE
System bandwidth	$f_{BW}$	15 kHz

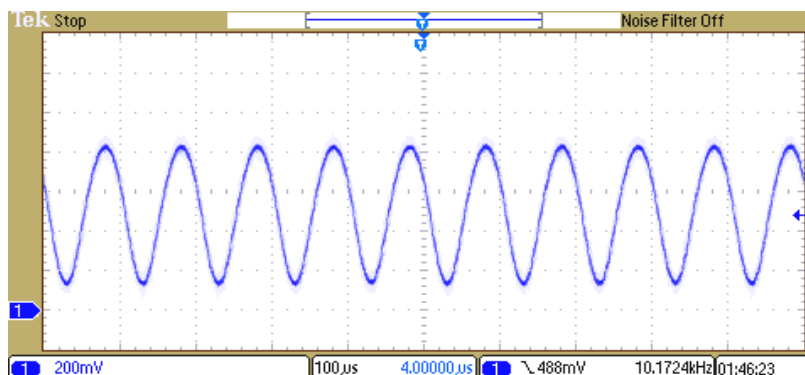
##### 9.2.1.2 Detailed Design Procedure

The DRV5053 has internal filtering that limits the bandwidth to at least 20 kHz. For this application no external components are required other than the C1 bypass capacitor, which is 0.01  $\mu$ F minimum. If the analog output OUT is tied to a microcontroller ADC input, the equivalent load must be  $R > 10$  k $\Omega$  and  $C < 10$  nF.

Table 2. External Components

COMPONENT	PIN 1	PIN 2	RECOMMENDED
C1	V <sub>CC</sub>	GND	A 0.01- $\mu$ F (minimum) ceramic capacitor rated for V <sub>CC</sub>

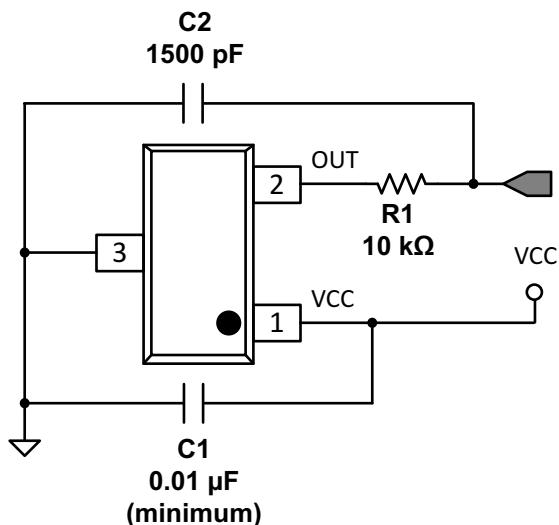
### 9.2.1.3 Application Curve



**Figure 13. 10-kHz Switching Magnetic Field**

### 9.2.2 Filtered Typical Application

For lower noise on the analog output OUT, additional RC filtering can be added to further reduce the bandwidth.



**Figure 14. Filtered Typical Application Schematic**

#### 9.2.2.1 Design Requirements

For this design example, use the parameters listed in [Table 3](#) as the input parameters.

**Table 3. Design Parameters**

DESIGN PARAMETER	REFERENCE	EXAMPLE VALUE
System bandwidth	$f_{BW}$	5 kHz

### 9.2.2.2 Detailed Design Procedure

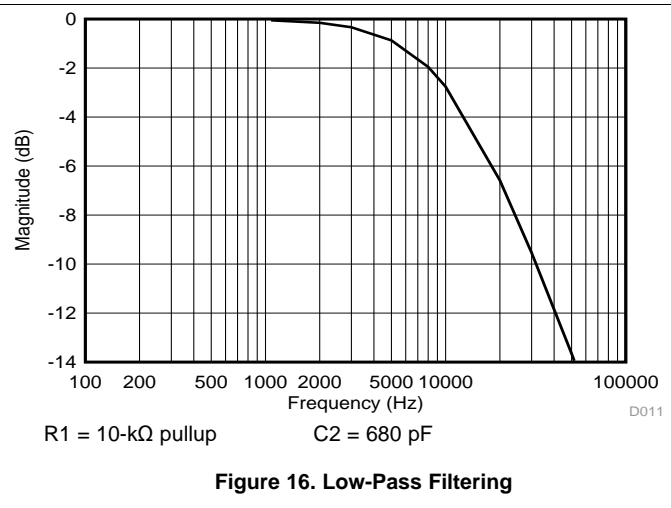
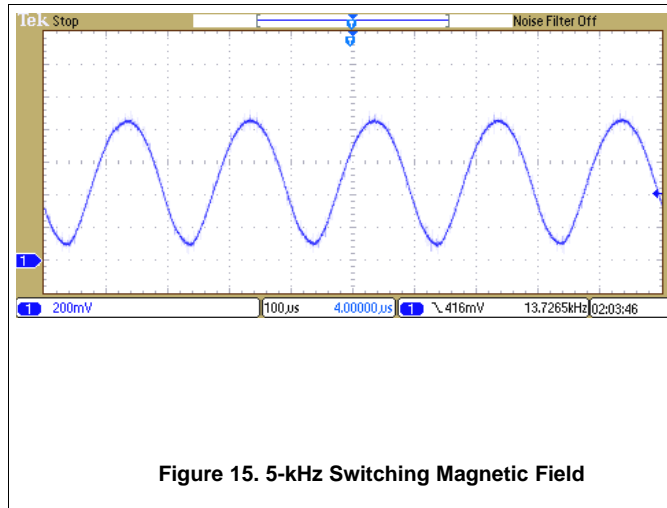
In this example we will add an external RC filter in order to reduce the output bandwidth.

In order to preserve the signal at the frequencies of interest, we will conservatively select a low-pass filter bandwidth (–3-dB point) at twice the system bandwidth (10 kHz).

$$10 \text{ kHz} < \frac{1}{2\pi \times R_1 \times C_2} \quad (1)$$

If we guess  $R_1 = 10 \text{ k}\Omega$ , then  $C_2 < 1590 \text{ pF}$ . So we select  $C_2 = 1500 \text{ pF}$ .

### 9.2.2.3 Application Curves



## 10 Power Supply Recommendations

The DRV5053 device is designed to operate from an input voltage supply (VM) range between 2.5 and 38 V. A 0.01-μF (minimum) ceramic capacitor rated for  $V_{CC}$  must be placed as close to the DRV5053 device as possible.

## 11 Device and Documentation Support

### 11.1 Device Support

#### 11.1.1 Device Nomenclature

Figure 17 shows a legend for reading the complete device name for and DRV5053 device.

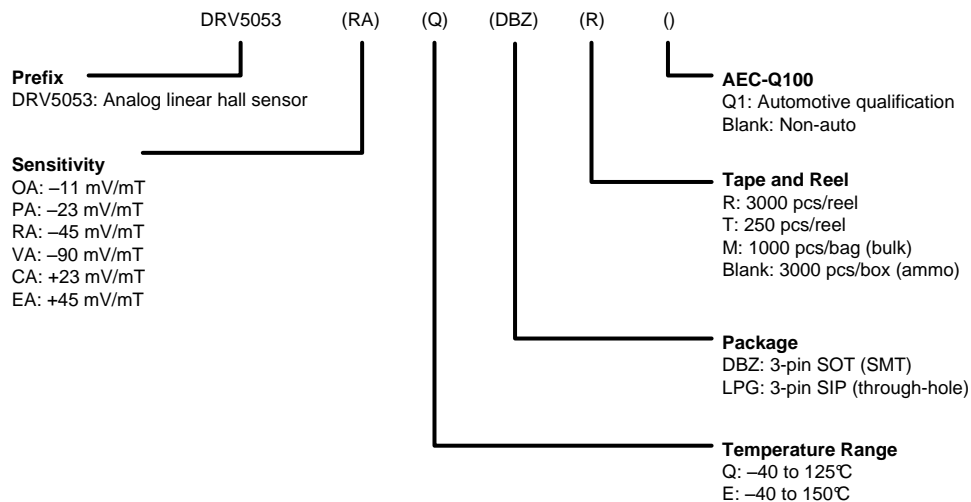


Figure 17. Device Nomenclature

#### 11.1.2 Device Markings

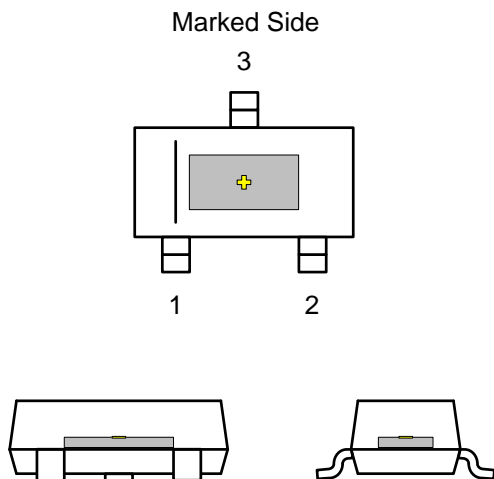


Figure 18. SOT-23 (DBZ) Package

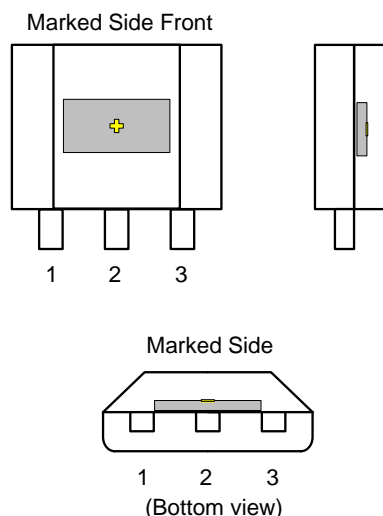


Figure 19. SIP (LPG) Package

✚ indicates the Hall effect sensor (not to scale). The Hall element is located in the center of the package with a tolerance of  $\pm 100 \mu\text{m}$ . The height of the Hall element from the bottom of the package is  $0.7 \text{ mm} \pm 50 \mu\text{m}$  in the DBZ package and  $0.987 \text{ mm} \pm 50 \mu\text{m}$  in the LPG package.

## 11.2 Trademarks

All trademarks are the property of their respective owners.

## 11.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## 11.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
DRV5053CAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALCA	<a href="#">Samples</a>
DRV5053CAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALCA	<a href="#">Samples</a>
DRV5053CAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALCA	<a href="#">Samples</a>
DRV5053CAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALCA	<a href="#">Samples</a>
DRV5053EAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALEA	<a href="#">Samples</a>
DRV5053EAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALEA	<a href="#">Samples</a>
DRV5053EAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALEA	<a href="#">Samples</a>
DRV5053EAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALEA	<a href="#">Samples</a>
DRV5053OAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALOA	<a href="#">Samples</a>
DRV5053OAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALOA	<a href="#">Samples</a>
DRV5053OAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALOA	<a href="#">Samples</a>
DRV5053OAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALOA	<a href="#">Samples</a>
DRV5053PAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALPA	<a href="#">Samples</a>
DRV5053PAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALPA	<a href="#">Samples</a>
DRV5053PAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALPA	<a href="#">Samples</a>
DRV5053PAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALPA	<a href="#">Samples</a>
DRV5053RAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALRA	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
DRV5053RAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALRA	<a href="#">Samples</a>
DRV5053RAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALRA	<a href="#">Samples</a>
DRV5053RAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALRA	<a href="#">Samples</a>
DRV5053VAQDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALVA	<a href="#">Samples</a>
DRV5053VAQDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+ALVA	<a href="#">Samples</a>
DRV5053VAQLPG	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALVA	<a href="#">Samples</a>
DRV5053VAQLPGM	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+ALVA	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF DRV5053 :**

- Automotive: [DRV5053-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

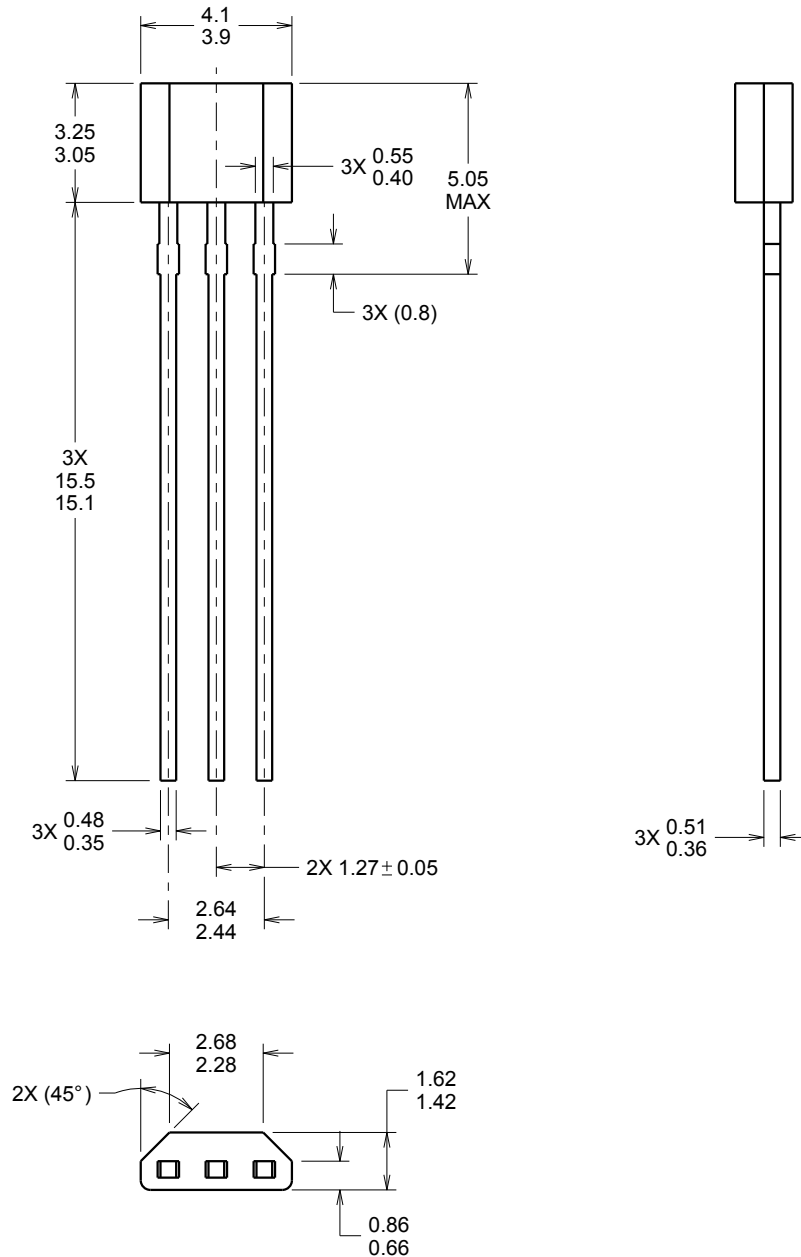
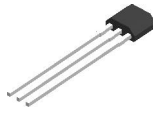
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DRV5053CAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053CAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053EAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053EAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053OAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053OAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053PAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053PAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053RAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053RAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053VAQDBZR	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053VAQDBZT	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DRV5053CAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053CAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053EAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053EAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053OAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053OAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053PAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053PAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053RAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053RAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053VAQDBZR	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053VAQDBZT	SOT-23	DBZ	3	250	202.0	201.0	28.0



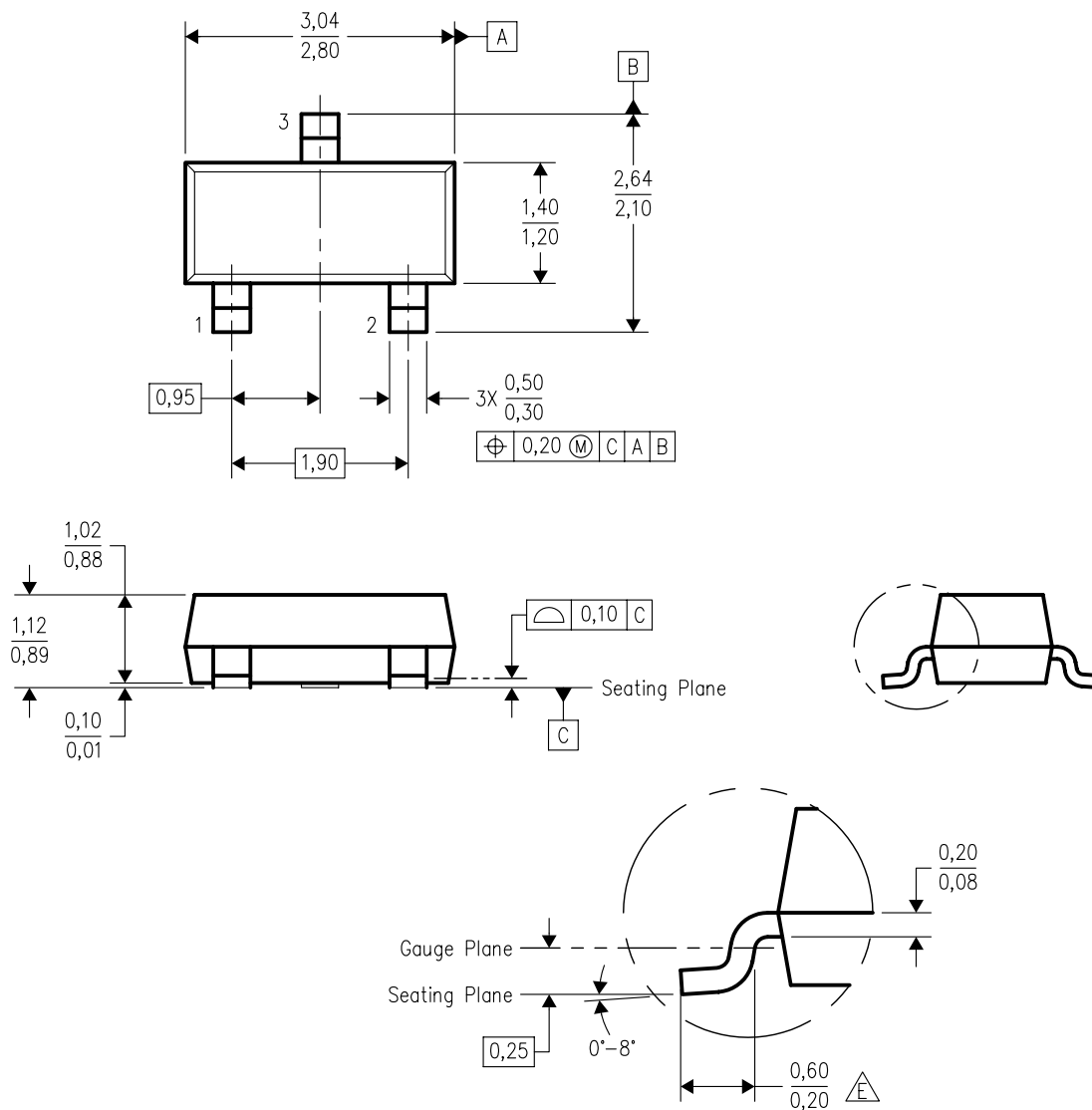
4221343/A 02/2014

## NOTES:


1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

## DBZ (R-PDSO-G3)

## PLASTIC SMALL-OUTLINE



4203227/B 04/2005

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Lead dimensions are inclusive of plating.
  - D. Body dimensions are exclusive of mold flash and protrusion. Mold flash and protrusion not to exceed 0.25 per side.
  -  E. Falls within JEDEC TO-236 variation AB, except minimum foot length.

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Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
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